

SOPN-MX28357000

Part number	LED color	Тур. ССТ	CRI	Typ. Luminous flux @ Tc 25°C	Typ. Luminous flux @Tc 65°C
SOPN-MW28357000	Cool white	5700K	>80	2160lm/m	1944lm/m
SOPN-MS28357000	Natural white	4000K	>80	2160lm/m	1944lm/m
SOPN-MN28357000/3000K	Warm white	3000K	>80	2015lm/m	1814lm/m
SOPN-MN28357000/2700K	Warm white	2700K	>80	1915lm/m	1732lm/m

Product features

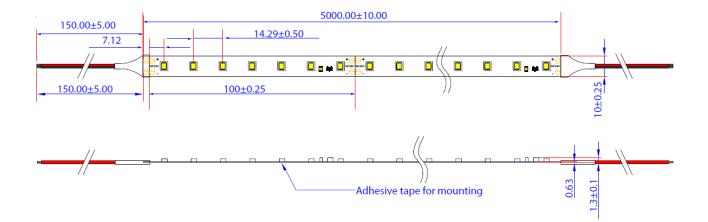
Dimensions	5000 x 10 mm			
PCB material	Flex			
LED	2835 pkg			
Supply voltage	24V			
Supply current	600mA/m			
Power dissipation	14,4W/m			
Inverse-polarity protection	no			
Connector	wires			
Energy Classification	A+ ab 09.20 D			
Protection	IP00			
Other	Sticky tape on backside			
Certification	IEC 62031; IEC 62778; IEC 62717; IEC 61000-4-2			



21.07.2020



Drawing :



Min Cutting length 100mm

Due to technical reasons, we are free to use an updated LED version without any notification to the customer.

Lumen maintenance for 2835-24v-70LED/M Series

Supply Voltage	Tp temperature	L90/F10	L90/F50	L80/F10	L80/F50	L70/F10	L70/F50
24V	40	>27,000 h	>29,000 h	>29,000 h	>30,000 h	>30,000 h	>30,000 h
24V	45	>26,000 h	>28,000 h	>28,000 h	>30,000 h	>30,000 h	>30,000 h
24V	55	>24,000 h	>26,000 h	>26,000 h	>30,000 h	>30,000 h	>30,000 h
24V	65	>22,000 h	>24,000 h	>25,000 h	>30,000 h	>30,000 h	>30,000 h
24V	75	>20,000 h	>22,000 h	>23,000 h	>30,000 h	>30,000 h	>30,000 h

21.07.2020



References:

- According to DIN EN 62031, the modules have to be evaluated as integrated modules and need to be tested in the lamp / application.
- Transient overvoltage can damage the module.
- The electrical safety of the module has to be evaluated in the application.
- A conformity test must be carried out after installation in the application.
- The components on the LED module are sensitive to electrostatic discharge (ESD)
- and electrical overstress (EOS).
- LEDs are encapsulated with silicon for a high optic efficiency.
- Do not touch the silicon with sharp or pointy objects such as tweezers.
- Fingerprints on the silicon may affect the optical characteristics.
- UV or sunlight may affect/discolor the silicon socketing.
- Do not use dissolver-containing glue.
- Do not modify the module.
- Only use tools specified for the voltage.
- Do not touch any parts, components or connectors on the PCB while the product is in operation.
- Do not change or modify the connecting cable while the module is in operation.
- Avoid solder beads, flux remains etc. to avoid short-circuits.
- Please store the LEDs in vacuum sealed bags to avoid dust.
- Do not exert mechanical pressure on the module since even low application of force can damage the components. Do not expose the module to high temperature, high humidity and direct sunlight.
- Do not cover or pot the LEDs with a different potting material such as Epoxy, Urethan.
- Any additional molding of the LED module is not recommended as the LED might be damaged by unqualified potting materials or methods. The optical characteristics of the LEDs might be changed by any kind of molding.
- Do not use sulfur-containing materials in the environment of the modules.
- Do not operate or mount the module in an environment with high humidity or gases such as CI, H2S, NH3, SO2, NOX, etc.
- Corrosion damage resulting from contact of the LED module with moisture and condensation water cannot be acknowledged as defect.
- The correct thermal management of the LED application has to be ensured by the customer. Insufficient thermal management may cause damage to the LED or to other components. A sufficient heat transfer has to be ensured by using a heat sink or similar.



21.07.2020



- Only operate the LED module using power supply in accordance to the technical specification.
- Be aware of the correct polarity
- The start-up of the LED modules (with power supply) must be carried out according to instructions of an electrically skilled person.

